

Features

- AEC-Q101 Qualified
- Split Gate Trench MOSFET Technology
- Excellent Package for Heat Dissipation
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Moisture Sensitivity Level 3

Maximum Ratings

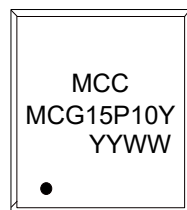
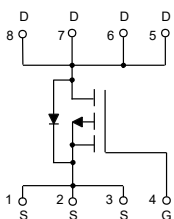
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 2.5°C/W Junction to Case
- Thermal Resistance: 50°C/W Junction to Ambient^(Note2)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	-15
		$T_C=100^\circ\text{C}$	-9.5
Pulsed Drain Current ^(Note3)	I_{DM}	-35	A
Total Power Dissipation ^(Note4)	P_D	50	W
Single Pulsed Avalanche Energy ^(Note5)	E_{AS}	64	mJ

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.
3. Pulse Test: Pulse Width≤300us, Duty cycle ≤2%.
4. P_d is based on max. junction temperature, using junction-case thermal resistance.
5. $V_{DD}=-50\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$.

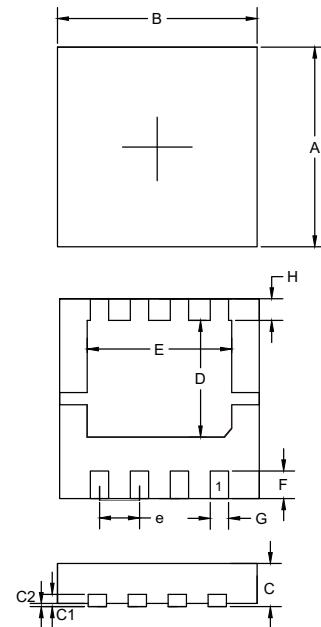
Internal Structure and Marking Code



4 codes in total
YY is the year
WW is the week

P-CHANNEL MOSFET

DFN3333



DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.126	0.130	3.20	3.30	
B	0.126	0.130	3.20	3.30	
C	0.030	0.033	0.75	0.85	
C1	0.007	0.009	0.18	0.22	
C2	---	0.002	---	0.05	
D	0.071	0.079	1.80	2.00	
E	0.087	0.098	2.20	2.50	
F	0.016	0.020	0.40	0.50	
G	0.010	0.014	0.25	0.35	
H	0.012	0.016	0.30	0.40	
e	0.024	0.028	0.60	0.70	

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-100			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-100V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.8	-2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-10A$		83	110	m Ω
		$V_{GS}=-4.5V, I_D=-5A$		95	120	
Gate Resistance	R_g	F=1MHz, Open Drain		10		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				-15	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-15A$			-1.3	V
Reverse Recovery Time	t_{rr}	$I_F=-5A, di_F/dt=100A/\mu s$		80		ns
Reverse Recovery Charge	Q_{rr}			140		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=-25V, V_{GS}=0V, f=1MHz$		1100		pF
Output Capacitance	C_{oss}			150		
Reverse Transfer Capacitance	C_{riss}			11		
Total Gate Charge	Q_g	$V_{DS}=-50V, V_{GS}=-10V, I_D=-5A$		20.1		nC
Gate-Source Charge	Q_{gs}			3.98		
Gate-Drain Charge	Q_{gd}			4.38		
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=-50V, V_{GS}=-10V, R_G=6\Omega, I_{DS}=-5A$		10		ns
Turn-On Rise Time	t_r			30		
Turn-Off Delay Time	$t_{d(off)}$			77		
Turn-Off Fall Time	t_f			81		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

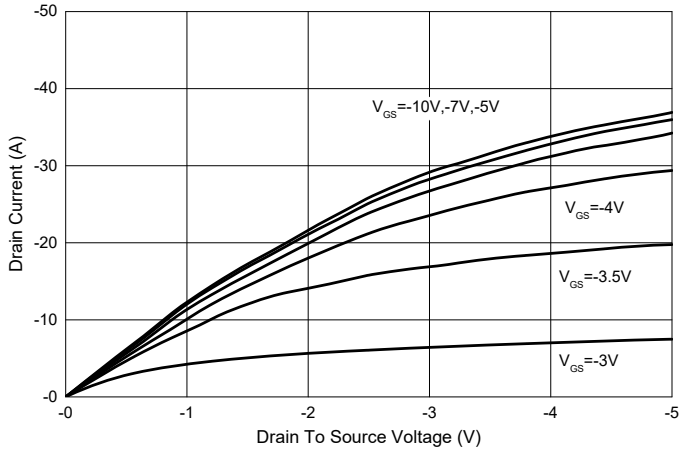


Fig. 2 - Transfer Characteristics

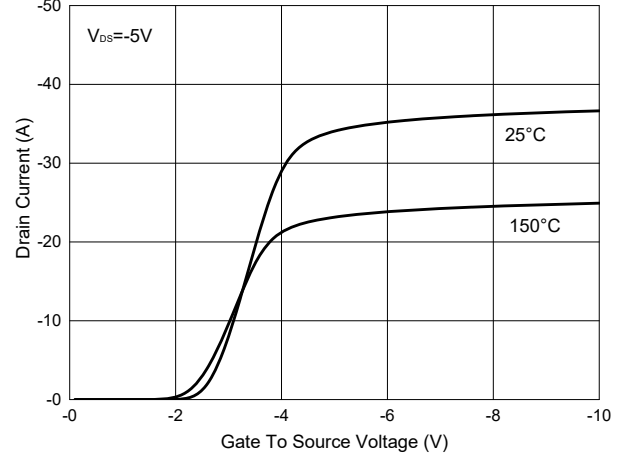


Fig. 3 - $R_{DS(ON)} - I_D$

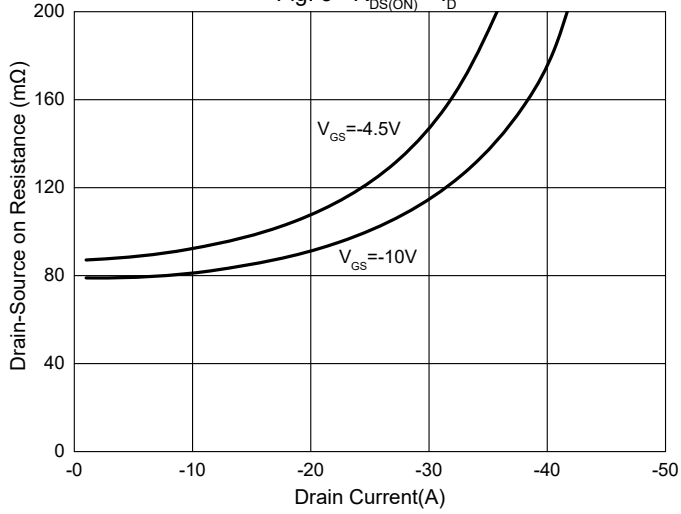


Fig. 4 - $R_{DS(ON)} - V_{GS}$

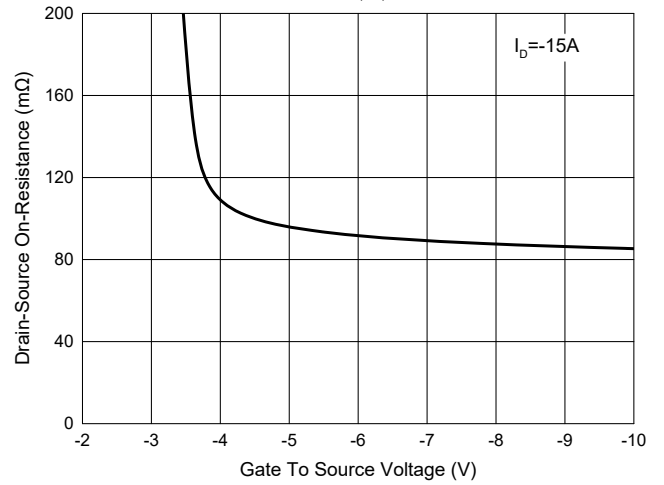


Fig. 5 - Capacitance Characteristics

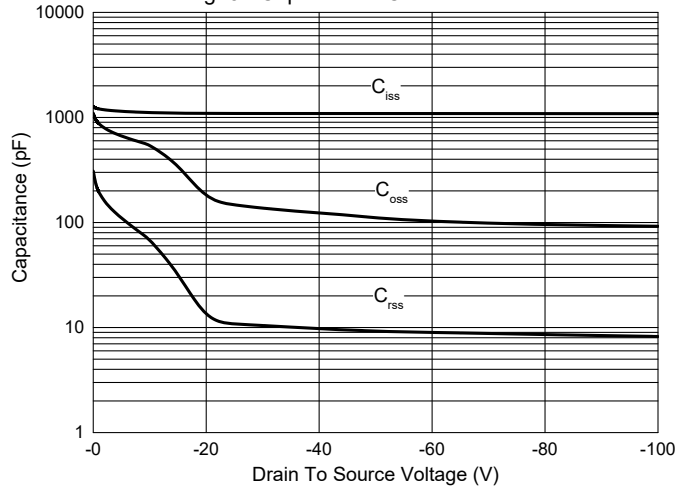
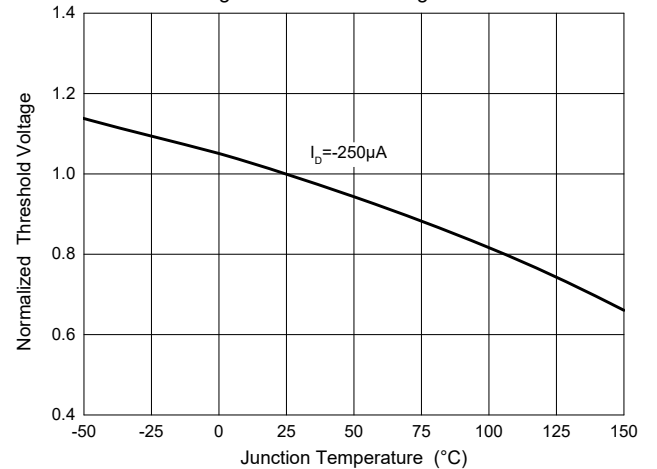
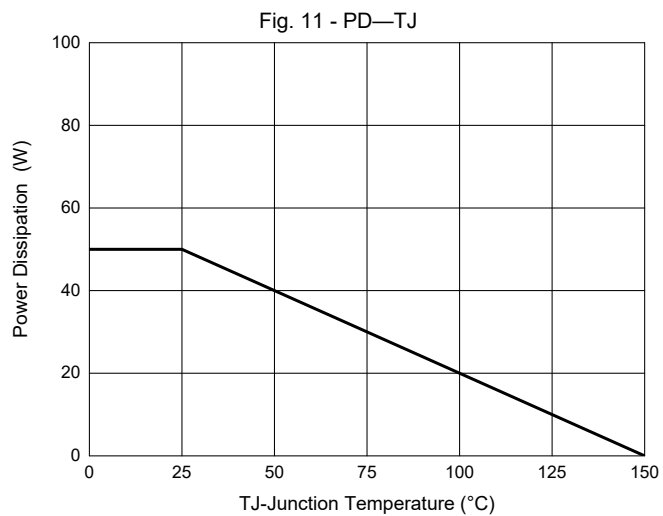
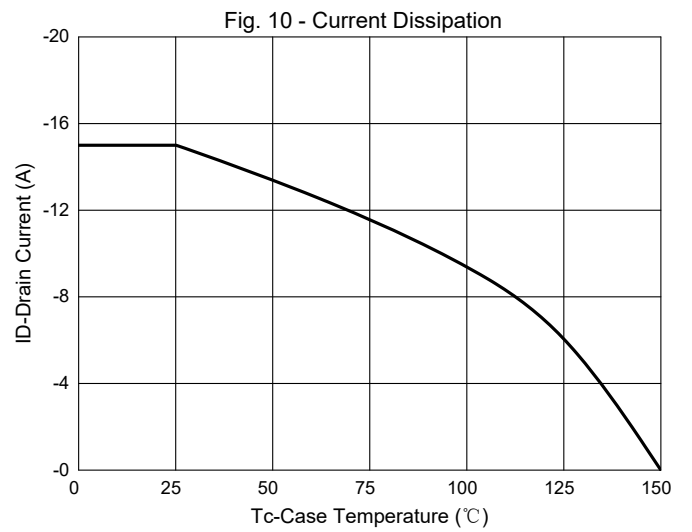
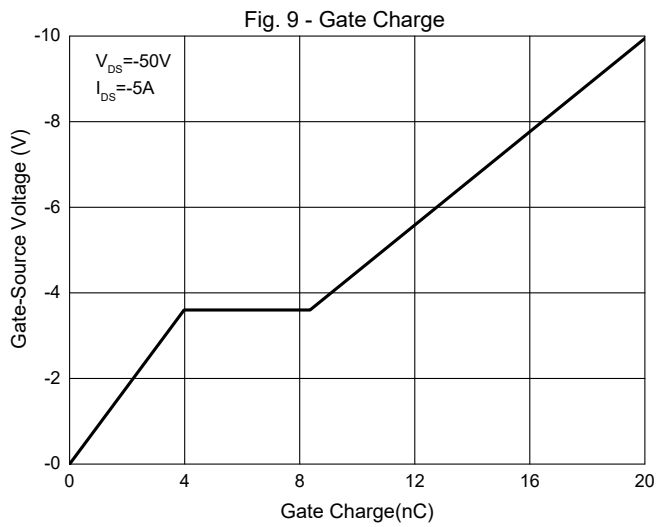
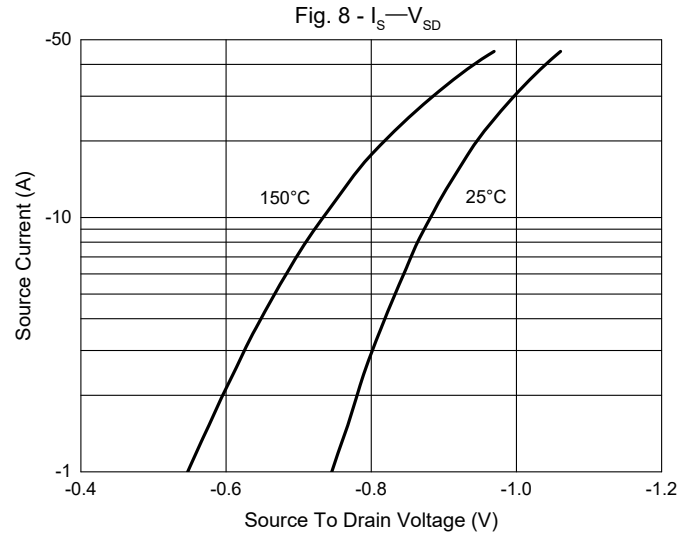
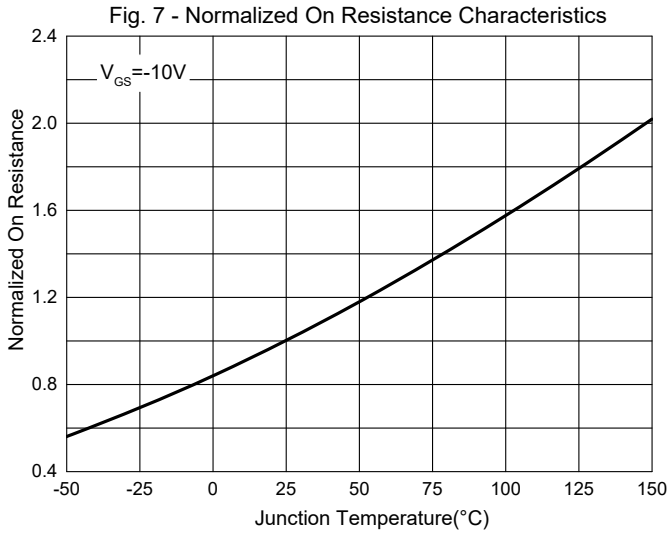


Fig. 6 - Threshold Voltage



Curve Characteristics



Curve Characteristics

Fig. 12 - Safe Operation Area

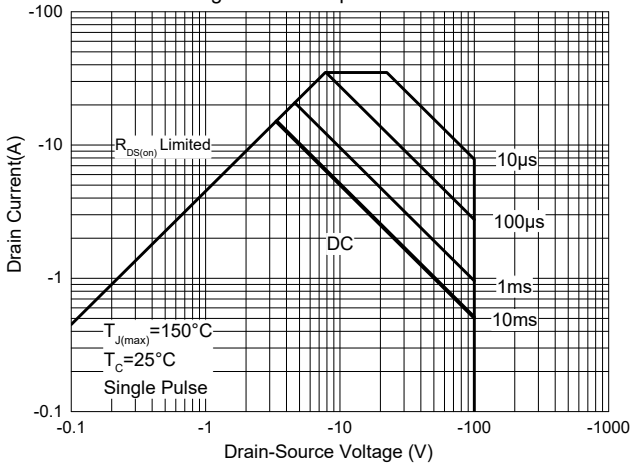
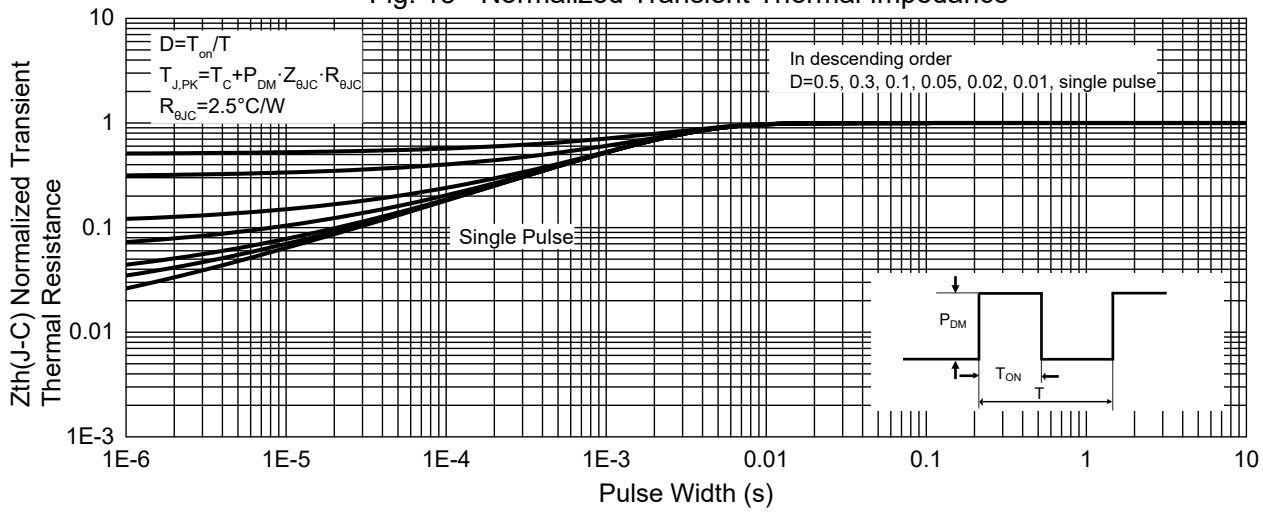


Fig. 13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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